



HT series

Photo Coupler Product Data Sheet

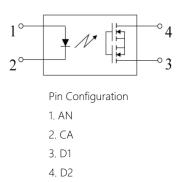
HTM-21X

Spec No:HT-PC-HTM-21X-P-021-A0 Effective Date:07/03/2024



■ Package





■ Description

The HTM-21X is solid state relays containing an AlGaAs infrared LEDs on the light emitting side (input side) optically coupled to a high voltage output detector circuit. The detector consists of a photovoltaic diode array and MOSFETs on the output side. The single channel configuration is equivalent to 1 form A EMR. The devices in a 4-pin small outline SOP package.

■ Features

- Normally open signal pole signal throw relay
- Low operating current
- 60 to 600V output withstand voltage
- Wide operating temperature range of -40°C to 85°C
- High input-output isolation voltage(Viso = 3,750Vrms)
- Safety approval
 (UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5), CQC11-471543-2022)
- RoHS
- MSL1

Applications

- Measurement equipment
- Exchange equipment
- A/OA equipment
- Security
- Industrial controls



■ Product Nomenclature

The product name is designated as below:

<u>HTM</u> -21X -X X- X X- <u>XX</u>

1 2 3 4 5

Designation:

HT =Hengtuo Technology Co.,LTD.

M =Sop4 Package Type

21X= Product Series(212,213,214,216)

- ① = Lead form option(NONE)₍₁₎
- ② = Tape and Reel option(TP,TP1,NONE)₍₂₎
- ③ = VDE order option(fixed code "V")
- ④ = Halogen free option(fixed code"G")
- ⑤ = Customer code

Notes

1. Lead form option:

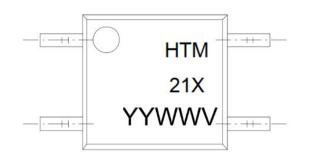
1. Load 101	1. Lodd form option:						
Symbol	Description						
NONE	SOP4						

2. Tape and Reel option:

Sym	ıbol	Description
TP&	TP1	Tape and Reel Type



■ Marking Information



Designation:

HT denotes Hengtuo
M denotes Sop 4 Package type
21X denotes Device
YY denotes year code
WW denotes week code
V denotes VDE

■ Maximum Ratings

	Parameter	Symbol	Values	s Unit
	Forward Current	l _F	50	mA
	Reverse Voltage	V_{R}	6	V
	Power Dissipation	Р	75	MW
Input	Peak Forward Current (100µs pulse, 100Hz)	I _{FP}	1	А
	Thermal Resistance Junction-Ambient	$R_{\text{thJ-A}}$	325	°C/W
	Thermal Resistance Junction-Case	$R_{\text{thJ-C}}$	200	°C/W
			HTM-212	60
	Break Down Voltage	V_{L}	HTM-213	100 V
	Break Down Voltage	۷L	HTM-214	400
			HTM-216	600
			HTM-212	550
Output	Continuous Load Current	ΙL	HTM-213	180 mA
Output	Continuous Load Current	IL.	HTM-214	120
			HTM-216	50
			HTM-212	1.2
	Pulse Load Current*(1)	li a	HTM-213	0.5 A
	i dise Load Guileilt (9	I _{LPeak}	HTM-214	0.3
			HTM-216).15
Power Di	ssipation	P _{out}	500	mW
Operating	g temperature range	T_{op}	−40 ~ 8 5	5 °C



Storage temperature range	T_{stg}	− 40 ~ 125	٥°
Total Power consumption	P(W)	550	mW
Isolation Voltage ⁽²⁾	V_{ISO}	3750	Vrms
Soldering Temperature ⁽³⁾	T _{SOL}	260	°C

Notes:

(1). A connection: 100ms (1 shot), VL = DC

(2)AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

(2).For 10 seconds

■ Electronic Optical Characteristics

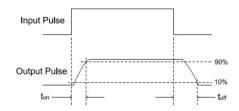
 $(TA = 25^{\circ}C)$

Parame	ter	Symb ol	Min.	Тур.	Max.	Unit	Conditon
Forward Vo	oltage	VF	-	1.2	1.5	V	I _F =10mA
Reverse C	urrent	I_R	-	-	1	μA	V _R =5V
Off State le	akage	I _{leak}	-	-	1	μΑ	I _F =0mA, V∟=Max
	HTM-212		-	0.7	2.5		
On	HTM-213	D	-	6.5	15	- - Ω -	I _F =10mA, I _L = Max. t = 1s
Resistance	HTM-214	rtd(ON) □	-	20	30		
	HTM-216	-	-	40	70		
	HTM-212		-	80	-	- - pF	VL = 0V, f = 1MHz
Output	HTM-213	•	-	60	-		
Capacitano	е HTM-214	- Cout -	-	45	-		
	HTM-216	-	-	30	-	•	
		IF _(on)		2.5	5	mA	IL = Max.
		IF _(off)	0.4	2.5	-	mA	IL = Max.
. Time	HTM-212	т	-	1.4	3	ma	IF = 10 mA, IL = Max. RL
i i iiiie —	HTM-213	I ON -		1.2	3	- ms	$= 200 \Omega,$
	Forward Volument Forwar	On Resistance HTM-213 HTM-214 HTM-216 HTM-216 HTM-212 HTM-213 HTM-213 HTM-214 HTM-216 LED turn on Current teristics LED turn off current HTM-212	Forward Voltage V _F - 1.2 1.5 V Reverse Current I _R - - 1 μA Off State leakage Current HTM-212 HTM-214 HTM-216 HTM-214 HTM-216 Output Capacitance HTM-214 HTM-216 HTM-216 HTM-217 HTM-218 Output Capacitance HTM-212 HTM-213 HTM-213				



HENGTOG EE	- werterzoewachnoose (
	HTM-214		-	0.4	3	
	HTM-216		-	1.4	3	
	HTM-212		_	0.05	0.5	
T 0% T'	HTM-213	т	-	0.05	0.5	
Turn Off Time	HTM-214	T_{OFF}	-	0.05	0.5	
	HTM-216		-	0.05	0.5	

Turn on/Turn off Time





■ Characteristics Curves

Fig.1 LED Dropout Voltage vs. Ambient Temperature

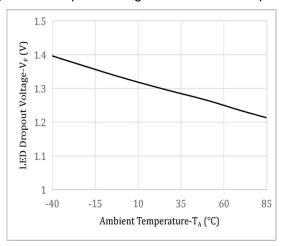


Fig.3 On Resistance vs. Ambient

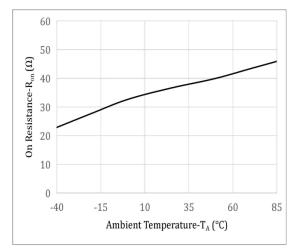


Fig.5 LED Operate Current vs. Ambient Temperature

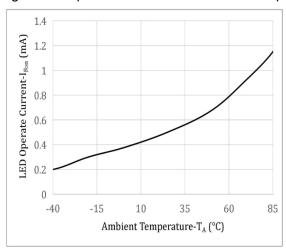


Fig.2 Output Current vs. Output Voltage

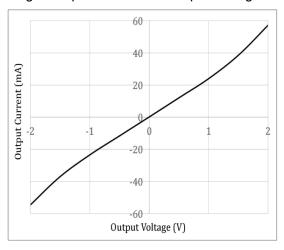


Fig.4 Load Current vs. Ambient Temperature

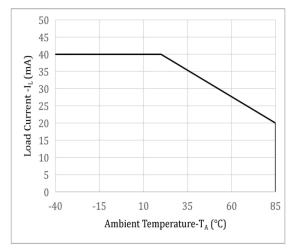


Fig.6 LED Turn Off Current vs. Ambient

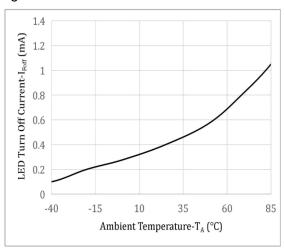




Fig.7 Turn On Time vs. Ambient Temperature

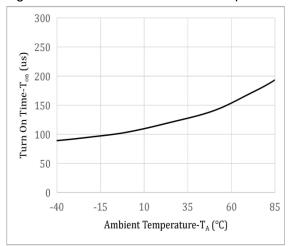


Fig.9 Turn On Time vs. LED Forward Current

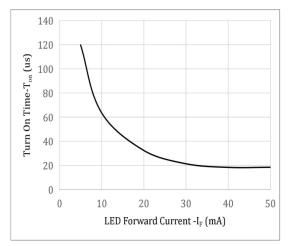


Fig.11 Off State Leakage Current vs Load Voltage

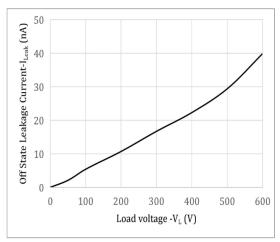


Fig.8 Turn Off Time vs. Ambient Temperature

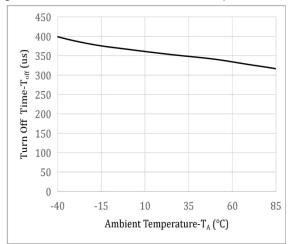
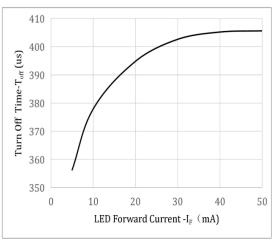
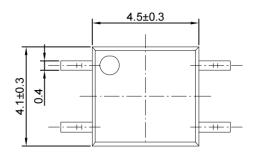


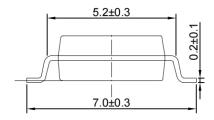
Fig.10 Turn Off Time vs. LED Forward

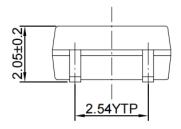




■ Outline Dimension



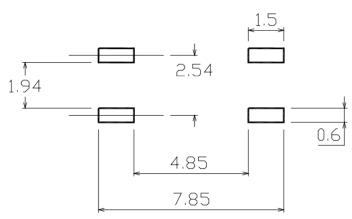




Unit: mm

Tolerance: ±0.1mm

■ Recommended solder pad Design



Unit: mm

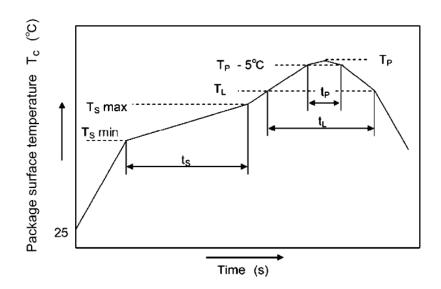
Tolerance: ±0.1mm



■ Temperature Profile Of Soldering

1. IR Reflow soldering (JEDEC-STD-020D compliant)

Profile item	Conditon
Preheat -Temperature Min (TSmin) -Temperature Max (TSmax) -Time (min to max) (ts)	150°C 200°C 90±30 sec
Soldering zone -Temperature (TL) -Time (t∟) Peak Temperature (TP) -Time (TP-5°C to TP) (ts)	217°C 60-150 sec 260°C 30 sec
Ramp-up rate	3°C / sec max
Ramp-down rate	3~6°C/ sec



Notes:

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.



2. Wave soldering (JEDEC22A111 compliant)

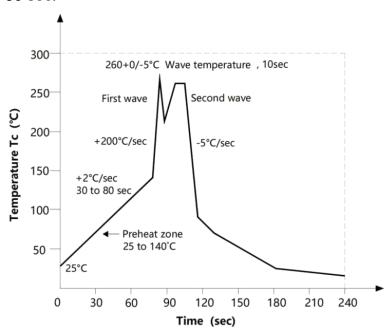
One time soldering is recommended within the condition.

Temperature:260+0/-5°C.

Time:10 sec.

Preheat temperature:25 to 140°C.

Preheat time: 30 to 80 sec.



3. Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380+0/-5°C

Time: 3 sec max.

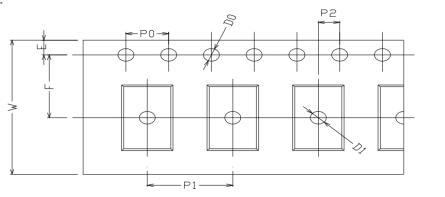
■ Packing

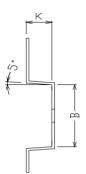
1. Tape and Reel

Option TP:

Option TP:









Deminsion/mm	W	E	F	P0	P1	P2
Packagetype:S	16±0.2	1.75±0.1	7.5±0.1	4±0.1	8±0.1	2±0.1

Deminsion/mm	A	В	D0	D1	K
Packagetype:S	4.4±0.1	7.5±0.1	1.5±0.1	1.5±0.1	2.4±0.1

Packagetype:S	Reel	Inner carton	Outer carton
QTY/PCS	3K/reel	9K(3 reels)	90K



■ Attention:

- Hengtuo is continually improving the quality, reliability, function or design and Hengtuo reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.

文件修订履历							
版本号	修订内容	修订人	修订日期				
AO	首次发布	劳厚顺	2024. 7. 3				